LNJ998CKBDA

Round Type

 $\phi 3.0 \ mm$

Absolute Maximum Ratings $T_a = 25^{\circ}C$

Parameter	Symbol	Rating	Unit	
Power dissipation	P _D	120	mW	
Forward current	I _F	30	mA	
Pulse forward current *	I _{FP}	100	mA	
Reverse voltage	V _R	5	V	
Operating ambient temperature	T _{opr}	-25 to +85	°C	
Storage temperature	T _{stg}	-30 to +100	°C	

Lighting Color

• Blue

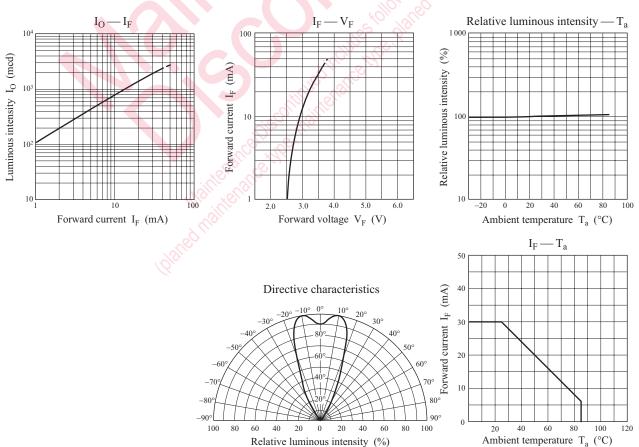
Note) *: The condition of I_{FP} is duty 10%, Pulse width 10 msec.

Electro-Optical Characteristics $T_a = 25^{\circ}C$

a i i							
Parameter	Symbol		Conditions	Min	Тур	Max	Unit
Luminous intensity *1	Io	$I_F = 20 \text{ mA}$		600	1500	30	mcd
Reverse current	I _R	$V_R = 5 V$,0 ⁰)	10	μΑ
Forward voltage	V _F	$I_F = 20 \text{ mA}$,00°, c	3.2	4.0	V
Dominant emission wavelength *2	λ_d	$I_F = 20 \text{ mA}$		457.5	459.0	460.0	nm

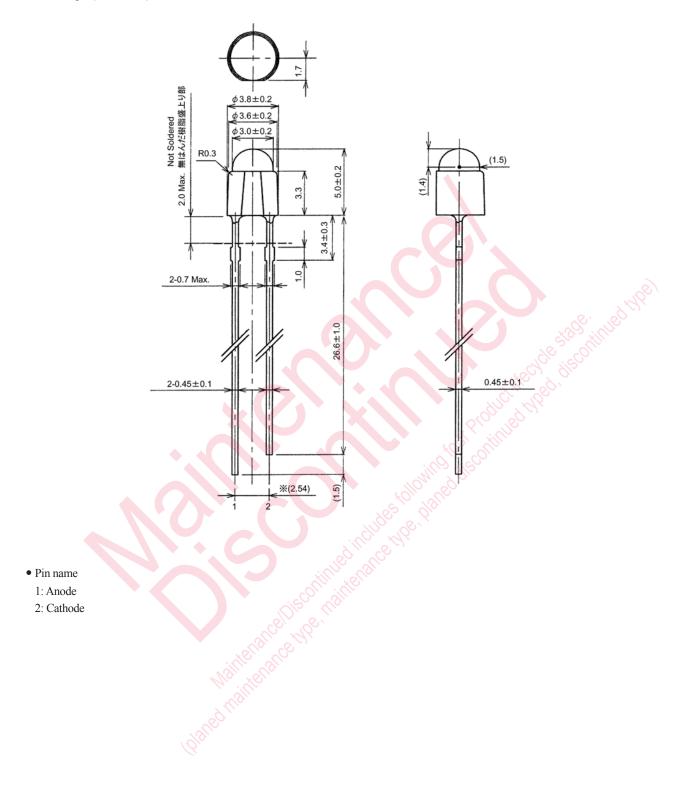
Note) *1: Measurement tolerance: ±20%

*2: Measurement tolerance: ±2 nm



Panasonic

Package (Unit: mm)



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